

L Number	Hits	Search Text	DB	Time stamp
1	609	(438/687).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:53
2	484110	copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:53
3	836479	copper or ("cu")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:54
5	235539	(copper or ("cu")) and treat\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:56
6	4708	((copper or ("cu")) and treat\$5) and (corros\$5 adj (inhibit\$5 or treat\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:58
7	255	((copper or ("cu")) and treat\$5) and (corros\$5 adj (inhibit\$5 or treat\$5)) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:58
8	38	((((copper or ("cu")) and treat\$5) and (corros\$5 adj (inhibit\$5 or treat\$5)) and semiconductor) and (anti-corros\$5 or (anti adj corros\$5)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:59
9	1	("6274478").PN.	USPAT	2002/08/06 15:08
-	2	((6329298") or ("4668335")).PN.	USPAT	2002/08/06 15:08
-	581	438/687	USPAT; EPO; JPO; DERWENT	2002/02/14 09:10
-	0	438/687 and (anti-corrosion adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/05 12:48
-	0	438/687 and ((anti-corrosion or (corros\$5 adj inhibit\$5)) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/05 12:48
-	0	438/687 and ((corros\$5 adj inhibit\$5) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:17
-	2	((corros\$5 adj inhibit\$5) adj treat\$5)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/05 12:50
-	16	(anti-corrosion adj treat\$5) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/05 12:50
-	18	((anti-corrosion or (corros\$5 adj inhibit\$5)) adj treat\$5)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/05 12:56
-	186	((corros\$5 adj inhibit\$5) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/05 12:56
-	223	anti-corrosion adj treat\$5	USPAT; EPO; JPO; DERWENT	2002/08/06 14:53
-	407	((anti-corrosion or (corros\$5 adj inhibit\$5)) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/05 13:12
-	3	((6329298") or ("4668335") or ("6323131")).PN.	USPAT	2002/02/05 13:43

-	5218	anti-corrosive	USPAT; EPO; JPO; DERWENT	2002/02/14 09:18
-	946	anti-corrosive and copper	USPAT; EPO; JPO; DERWENT	2002/02/14 09:18
-	450808	copper	USPAT; EPO; JPO; DERWENT	2002/02/14 09:18
-	946	copper and anti-corrosive	USPAT; EPO; JPO; DERWENT	2002/02/14 09:28
-	0	(copper and anti-corrosive) and (hetero-cyclic)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:19
-	2	(copper and anti-corrosive) and (hetero adj cyclic)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:19
-	0	((copper and anti-corrosive) and (hetero adj cyclic)) and (indazole)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:29
-	4	(copper and anti-corrosive) and (indazole)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:24
-	0	((copper and anti-corrosive) and (indazole)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/14 09:29
-	2175	copper and ((anti-corrosive) or (anti adj corrosion))	USPAT; EPO; JPO; DERWENT	2002/02/14 10:28
-	0	((copper and ((anti-corrosive) or (anti adj corrosion))) and (indazole)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/14 09:30
-	12	(copper and ((anti-corrosive) or (anti adj corrosion))) and (indazole)	USPAT; EPO; JPO; DERWENT	2002/02/14 10:29
-	171	(copper and ((anti-corrosive) or (anti adj corrosion))) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/19 12:34
-	0	((copper and ((anti-corrosive) or (anti adj corrosion))) and semiconductor) and (indazole)	USPAT; EPO; JPO; DERWENT	2002/02/14 10:02
-	52420	copper and ((anticorros\$3) or (corros\$3))	USPAT; EPO; JPO; DERWENT	2002/02/14 10:29
-	163	(copper and ((anticorros\$3) or (corros\$3))) and (indazole)	USPAT; EPO; JPO; DERWENT	2002/02/14 10:29
-	20	((copper and ((anticorros\$3) or (corros\$3))) and (indazole)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/14 10:32
-	16	((copper and ((anticorros\$3) or (corros\$3))) and (indazole)) and (interconnect\$3 or wir\$4 or (sheet adj metal))	USPAT; EPO; JPO; DERWENT	2002/02/14 14:37
-	3	("5391257") or ("5641381") or ("5455202").PN.	USPAT	2002/02/14 14:38
-	172	(copper and ((anti-corrosive) or (anti adj corrosion))) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/19 12:39
-	3	((copper and ((anti-corrosive) or (anti adj corrosion))) and semiconductor) and (SiON or (silicon adj oxygen adj nitrogen))	USPAT; EPO; JPO; DERWENT	2002/02/19 12:38
-	2176	(copper and ((anti-corrosive) or (anti adj corrosion)))	USPAT; EPO; JPO; DERWENT	2002/02/19 12:38
-	3	((copper and ((anti-corrosive) or (anti adj corrosion)))) and (SiON or (silicon adj oxygen adj nitrogen))) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/19 12:39

-	23	((copper and ((anti-corrosive) or (anti adj corrosion)))) and (SiON or (silicon adj oxygen adj nitrogen))	USPAT; EPO; JPO; DERWENT	2002/02/19 12:39
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L Number	Hits	Search Text	DB	Time stamp
13	1108	(438/780).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:09
14	609	(438/687).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/08/06 14:10
-	2	(("6329298") or ("4668335")).PN.	USPAT	2002/02/05 13:43
-	581	438/687	USPAT; EPO; JPO; DERWENT	2002/02/14 09:10
-	0	438/687 and (anti-corrosion adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/08/05 11:36
-	0	438/687 and ((anti-corrosion or (corros\$5 adj inhibit\$5)) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/05 12:48
-	0	438/687 and ((corros\$5 adj inhibit\$5) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:17
-	2	((corros\$5 adj inhibit\$5) adj treat\$5)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/05 12:50
-	16	(anti-corrosion adj treat\$5) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/05 12:50
-	18	((anti-corrosion or (corros\$5 adj inhibit\$5)) adj treat\$5)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/05 12:56
-	186	((corros\$5 adj inhibit\$5) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/05 12:56
-	223	anti-corrosion adj treat\$5	USPAT; EPO; JPO; DERWENT	2002/02/05 12:57
-	407	((anti-corrosion or (corros\$5 adj inhibit\$5)) adj treat\$5)	USPAT; EPO; JPO; DERWENT	2002/02/05 13:12
-	3	((("6329298") or ("4668335") or ("6323131")).PN.	USPAT	2002/02/05 13:43
-	5218	anti-corrosive	USPAT; EPO; JPO; DERWENT	2002/02/14 09:18
-	946	anti-corrosive and copper	USPAT; EPO; JPO; DERWENT	2002/02/14 09:18
-	450808	copper	USPAT; EPO; JPO; DERWENT	2002/02/14 09:18
-	946	copper and anti-corrosive	USPAT; EPO; JPO; DERWENT	2002/02/14 09:28
-	0	(copper and anti-corrosive) and (hetero-cyclic)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:19
-	2	(copper and anti-corrosive) and (hetero adj cyclic)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:19
-	0	((copper and anti-corrosive) and (hetero adj cyclic)) and (indazole)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:29
-	4	(copper and anti-corrosive) and (indazole)	USPAT; EPO; JPO; DERWENT	2002/02/14 09:24
-	0	((copper and anti-corrosive) and (indazole)) and semiconductor	USPAT; EPO; JPO; DERWENT	2002/02/14 09:29